Chassis decoupling caps for connector

Engineer: Tuan Tran

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Automotive, 42V Wide VIN, Fixed 3.3V, 1 Amp, 2.1MHz, Buck

5MBPS CAN FD Transceiver with I/O Level Shifting in DFN Package

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Orderable: Not Orderable

Contact: http://www.ti.com/support
You should delete the nylon screws/standoffs and/or the bumpers as needed for your design (or substitute other parts from Hardware.IntLib). Bumpers are cheaper, but provide less clearance.

Deleting anything else from this page may result in your EVM submission being rejected (until you add them back).

Update the Label Text in the Label Table as needed for each Assembly Variant.

You should delete this note too.
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Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
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